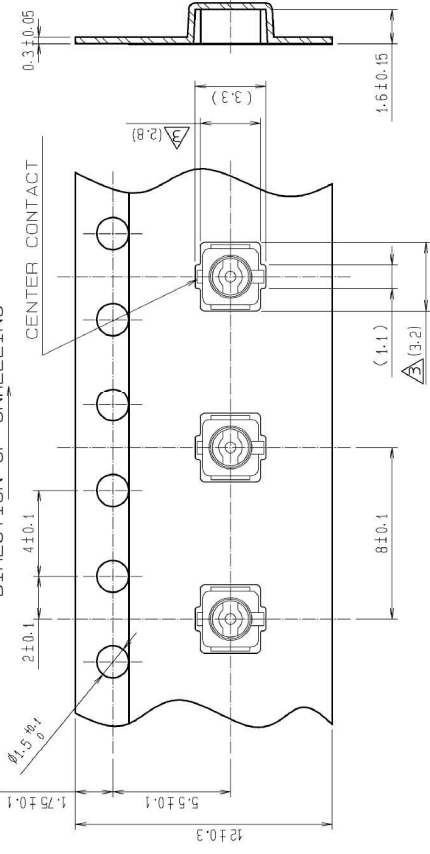
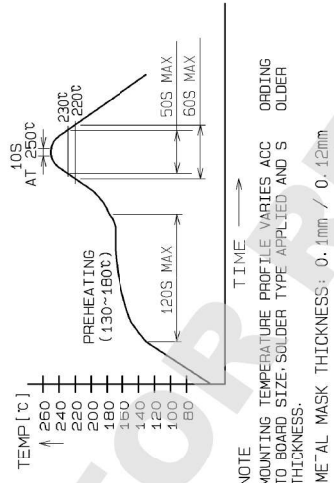


EMBOSSED TAPING DRAWING (4:1)

DIRECTION OF UNREELING

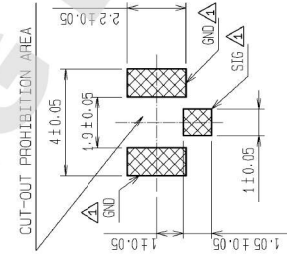


MOUNTING TEMPERATURE PROFILE (REFERENCE)



NOTE
MOUNTING TEMPERATURE PROFILE VARIES ACC TO BOARD SIZE, SOLDER TYPE APPLIED AND SOLDER THICKNESS.
-METAL MASK THICKNESS: 0.1mm / 0.12mm
-Up to 2cycles of Reflow.

RECOMMENDED PC BOARD PATTERN DRAWING (5:1)



NOTES:
1: THE QUANTITY OF U.FL-R-SMT(10) IS 2500 CONNECTORS PER REEL.

2: THIS DIMENSION SHOWS THE ALLOWABLE RANGE THAT THE RESIN IS PUT OVER THE CENTER CONTACT.

3: LEAD CO-PLANARITY SHALL BE 0.1MAX.

4: FOR THE POSSIBILITY OF BREAKAGE OR DEFORMATION, DO NOT MATE THIS CONNECTOR WITH PARTNER, U.FL-LP-*** BEFORE MOUNTING ON PC BOARD.

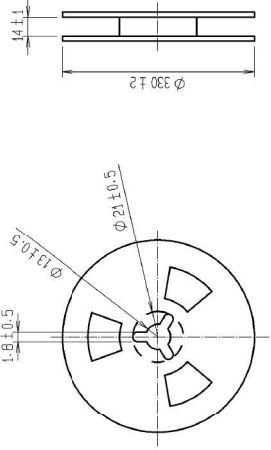
5: USE ALL PRODUCTS WITHIN 6 MONTHS AFTER THE DELIVERY. STORE THEM IN MANUFACTURER'S PACKAGE OR TIGHTLY RE-CLOSED BOX WITH THE FOLLOWING CONDITIONS. CHECK THE TERMINAL SOLDERABILITY BEFORE USE IF THE PRODUCT HAS BEEN STORED FOR MORE THAN 6 MONTHS.
TEMPERATURE: -10°C TO +40°C
HUMIDITY: 15 TO 85% RH.

6: ENVIRONMENTAL CONDITIONS DO NOT USE THE PRODUCTS UNDER THE ENVIRONMENTAL CONDITIONS AS SHOWN BELOW DUE TO POSSIBLE PRODUCT DETERIORATION.

SPECIAL GAS ATMOSPHERE (HYDROGEN SULFIDE GAS, SULFUR SULFIDE GAS AND HYDROGEN CHLORIDE GAS) PLACE ATTENTION REQUIRED: HEATING SYSTEM, AREA NEAR HOT SPRING, VOLCANIC MOUNTAIN AND ALIKE.

WATER SPLASHED AND CONDENSATION PLACES. PLACE ATTENTION REQUIRED: HARSH TEMPERATURE CHANGE.

REEL DRAWING (SCALE FREE)



NO.	MATERIAL	FINISH	COUNT	REMARKS	NO.	MATERIAL	DESIGNED	CHECKED	DATE
2	BRASS			GOLD PLATING	3	LCP			
1	PHOSPHOR BRONZE			SILVER PLATING					(BEIGE) . ULS4V-0
UNITS mm		SCALE 10:1	2	DESCRIPTION OF REVISIONS	DESIGNED		CHECKED		DATE
				APPROVED: I.J. MITANI	MT. KANEKO		NK. NINOMIYA		10.12.10
				CHECKED: MH. YAMANE	05.01.05		05.01.05		
				DESIGNED: NK. NINOMIYA	05.01.05		05.01.05		
				DRAWN: MA. SAEKI	05.01.05		05.01.05		
				DRAWING NO.	EDC3-131821-10				
				PART	U.FL-R-SMT(10)				
				CODE	CL331-0471-0-10				
				NO.	1				